

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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ECX-1247Q SMD Crystal

Request a Sample

VID Grysla



The ECX-1247Q is a very compact SMD Crystal with a $1.6 \times 1.2 \text{ mm}$ footprint. AEC-Q200 Qualified.

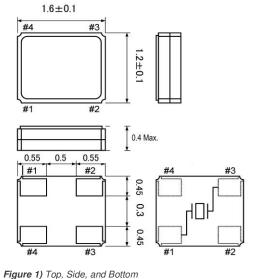
OPERATING CONDITIONS / ELECTRICAL CHARACTERISTICS



- Low Profile
- 1.6 x 1.2 mm Footprint
- RoHS Compliant
- AEC-Q200 Qualified

Of ENATING CONDITIONS / ELECTRICAL CHARACTERISTICS						
PARAMETERS	CONDITIONS	ECX-1247Q			UNITS	
		MIN	TYP	MAX		
Frequency		24.000		60.000	MHz	
Mode of Oscillation	Fundamental					
Frequency Tolerance*	@ +25°C			± 30	ppm	
Frequency Stability*	-40 ~ +125°C (ES Opt)			± 50	ppm	
Shunt Capacitance	Co			5	рF	
Load Capacitance	Specify in P/N		8		pF	
Drive Level	DL		10	100	μW	
Operating Temperature*	Topr (S Opt)	-40		+125	°C	
Storage Temperature	Tstg	-40		+125	°C	
Aging (Per Year)	@ +25°C ±3°C			±5	ppm	

DIMENSIONS (mm)



0.75	0.75
A	
0.75	

 Pad Connections

 1
 In/Out

 2
 Gnd

 3
 Out/In

 4
 NC

Figure 2) Suggested land pattern

Frequency (MHz)	ESR Ω Max.			
24.000 ~ 40.000	150			
41.000 ~ 60.000	100			

, ,

Crystal is symmetrical, pad 1 & 3 are interchangeable. Chamfer on the bottom pad has no electrical significance.

PART NUMBERING GUIDE: Example ECS-260-8-47Q-CES-TR

1.05

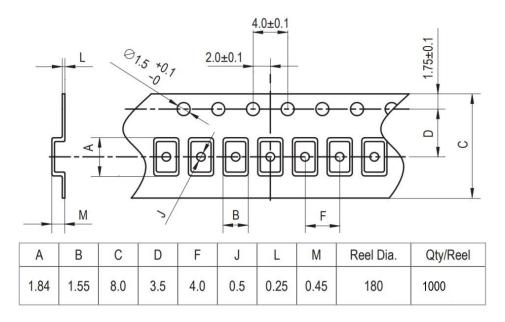
ECS - FREQUENCY ABBREVIATION	LOAD	PACKAGE		AVAILABLE OP		PACKAGING
	CAPACITANCE		Tolerance	Stability	Temp Range	
260 = 26.000 MHz See P/N Guide	8 = 8 pF S=Series	47Q = Blank = ±3 ECX- 1247Q	pm E om G pm H pm T	= ±100 ppm = ±50 ppm = ±30 ppm † = ±25 ppm † = ±20 ppm † '= ±15 ppm † = ±10 ppm †	L = -10 ~ +70°C M = -20 ~ +70°C Y = -30 ~ +85°C N = -40 ~ +105°C S = -40 ~ +125°C	

[†] Contact ECS for availability over extended temp range.

Rev.2018



POCKET TAPE DIMENSIONS (mm)



SOLDER PROFILE
Peak solder Temp +260°C Max 10 sec Max.
2 Cycles Max.
MSL 1, Lead Finish Au

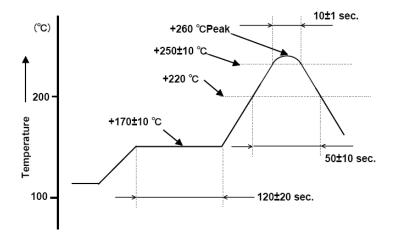


Figure 1) Suggested Reflow Profile